



GaAs InGaP HBT MMIC POWER AMPLIFIER, 1.6 - 2.2 GHz

Typical Applications

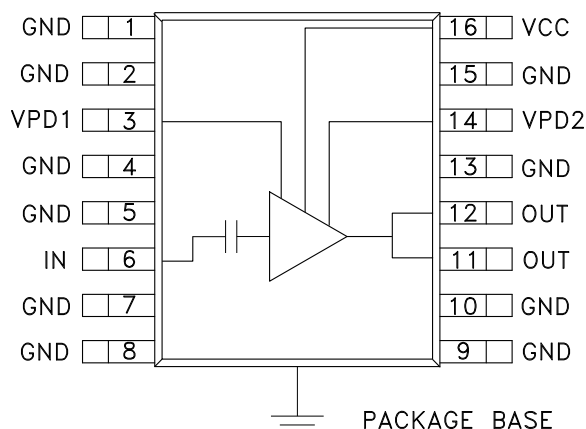
This amplifier is ideal for use as a power/driver amplifier for 1.6 - 2.2 GHz applications:

- Cellular / PCS / 3G
- Portable & Infrastructure
- Wireless Local Loop

Features

Gain: 23 dB
Saturated Power: +29.5 dBm
42% PAE
Supply Voltage: +2.75V to +5V
Power Down Capability
Low External Part Count
Included in the HMC-DK002 Designer's Kit

Functional Diagram



General Description

The HMC413QS16G & HMC413QS16GE are high efficiency GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC Power amplifiers which operate between 1.6 and 2.2 GHz. The amplifier is packaged in a low cost, surface mount 16 lead package with an exposed base for improved RF and thermal performance. With a minimum of external components, the amplifier provides 23 dB of gain, +29.5 dBm of saturated power at 42% PAE from a +5V supply voltage. The amplifier can also operate with a 3.6V supply. Vpd can be used for full power down or RF output power/current control.

Electrical Specifications, $T_A = +25^\circ\text{C}$, As a Function of V_s , $V_{pd} = 3.6\text{V}$

| Parameter | Frequency | $V_s = 3.6\text{V}$ | | | $V_s = 5\text{V}$ | | | Units |
|--|----------------------------------|---------------------|-----------|-------|-------------------|-----------|-------|----------------------|
| | | Min. | Typ. | Max. | Min. | Typ. | Max. | |
| Gain | 1.6 - 1.7 GHz | 18 | 21 | | 19 | 22 | | dB |
| | 1.7 - 2.0 GHz | 19 | 22 | | 20 | 23 | | dB |
| | 2.0 - 2.1 GHz | 18 | 21 | | 19 | 22 | | dB |
| | 2.1 - 2.2 GHz | 17 | 20 | | 18 | 21 | | dB |
| Gain Variation Over Temperature | 1.6 - 2.2 GHz | | 0.025 | 0.035 | | 0.025 | 0.035 | dB/ $^\circ\text{C}$ |
| Input Return Loss | 1.6 - 2.2 GHz | | 10 | | | 10 | | dB |
| Output Return Loss | 1.6 - 2.2 GHz | | 8 | | | 9 | | dB |
| Output Power for 1 dB Compression (P1dB) | 1.6 - 1.7 GHz | 20 | 23 | | 23 | 26 | | dBm |
| | 1.7 - 2.2 GHz | 21 | 24 | | 24 | 27 | | dBm |
| Saturated Output Power (Psat) | 1.6 - 1.7 GHz | | 25.5 | | | 28.5 | | dBm |
| | 1.7 - 2.2 GHz | | 26.5 | | | 29.5 | | dBm |
| Output Third Order Intercept (IP3) | 1.6 - 1.7 GHz | 32 | 35 | | 36 | 39 | | dBm |
| | 1.7 - 2.0 GHz | 33 | 36 | | 37 | 40 | | dBm |
| | 2.0 - 2.2 GHz | 32 | 35 | | 36 | 39 | | dBm |
| Noise Figure | 1.6 - 2.2 GHz | | 5.5 | | | 5.5 | | dB |
| Supply Current (Icq) | $V_{pd} = 0\text{V}/3.6\text{V}$ | | 0.002/220 | | | 0.002/270 | | mA |
| Control Current (Ipd) | $V_{pd} = 3.6\text{V}$ | | 7 | | | 7 | | mA |
| Switching Speed | tON, tOFF | | 80 | | | 80 | | ns |

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HMC413* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

- HMC413QS16G Evaluation Board

DOCUMENTATION

Application Notes

- AN-1363: Meeting Biasing Requirements of Externally Biased RF/Microwave Amplifiers with Active Bias Controllers
- Broadband Biasing of Amplifiers General Application Note
- MMIC Amplifier Biasing Procedure Application Note
- Thermal Management for Surface Mount Components General Application Note

Data Sheet

- HMC413 Data Sheet

TOOLS AND SIMULATIONS

- HMC413 S-Parameter

REFERENCE MATERIALS

Quality Documentation

- HMC Legacy PCN: QS##, QS##E and QS##G,QS##GE packages - Relocation of pre-existing production equipment to new building
- Package/Assembly Qualification Test Report: Plastic Encapsulated QSOP (QTR: 02015 REV: 11)
- PCN: MS, QS, SOT, SOIC packages - Sn/Pb plating vendor change
- Semiconductor Qualification Test Report: GaAs HBT-B (QTR: 2013-00229)

DESIGN RESOURCES

- HMC413 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC413 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

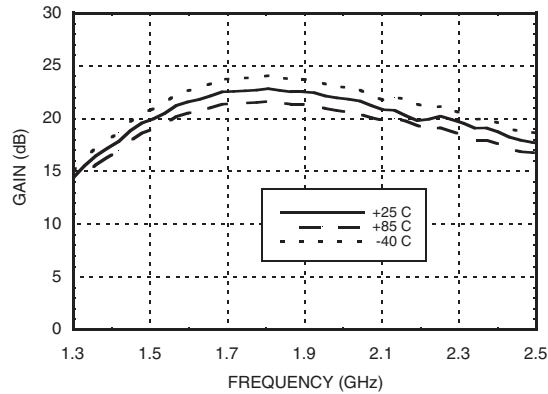
TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

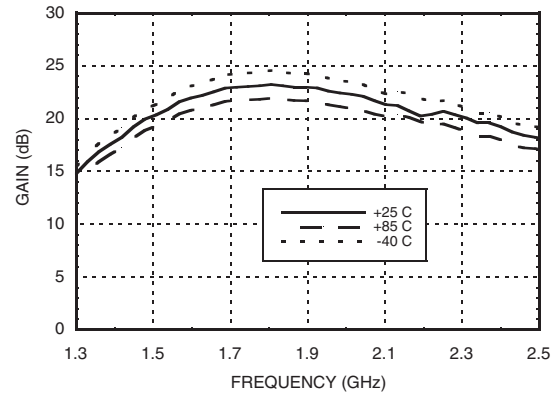
DOCUMENT FEEDBACK

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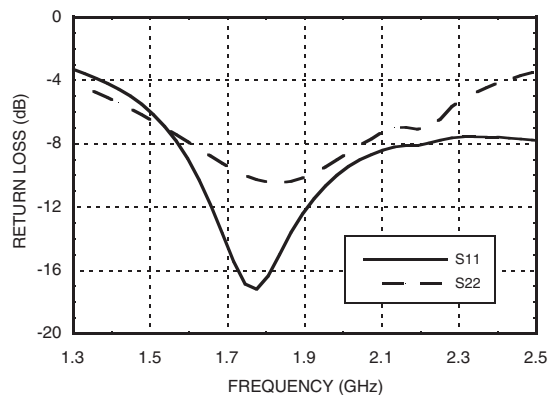
Gain vs. Temperature, $V_s = 3.6V$



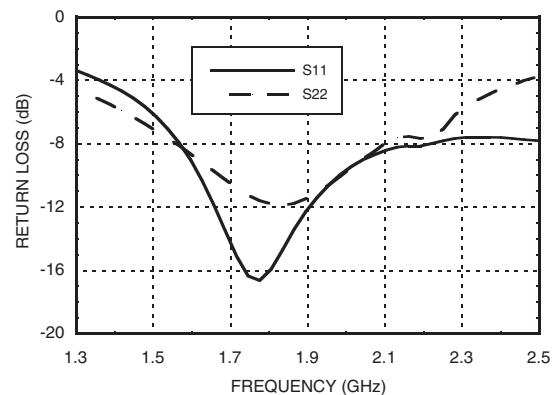
Gain vs. Temperature, $V_s = 5V$



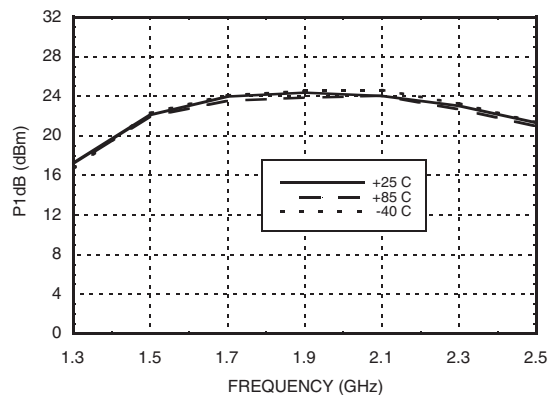
Return Loss, $V_s = 3.6V$



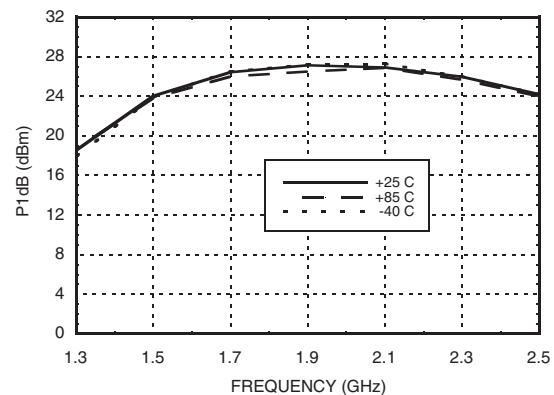
Return Loss, $V_s = 5V$



P1dB vs. Temperature, $V_s = 3.6V$



P1dB vs. Temperature, $V_s = 5V$

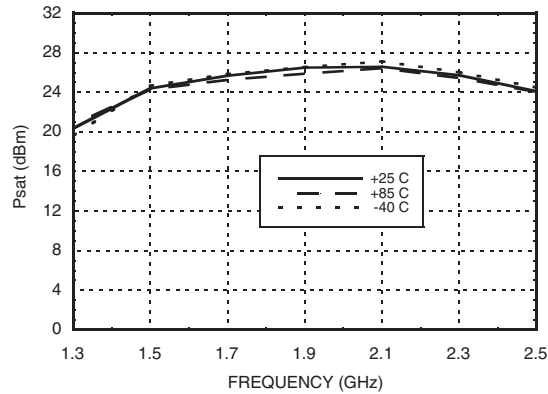




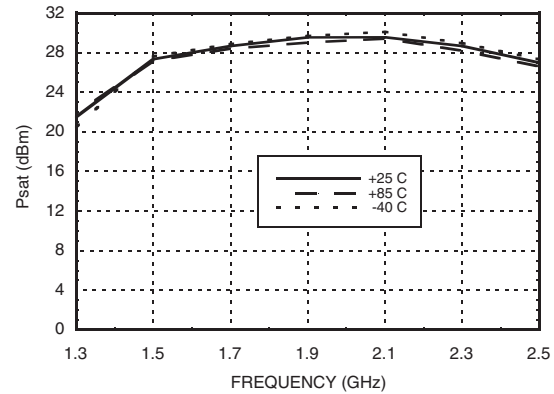
HMC413QS16G / 413QS16GE

GaAs InGaP HBT MMIC POWER AMPLIFIER, 1.6 - 2.2 GHz

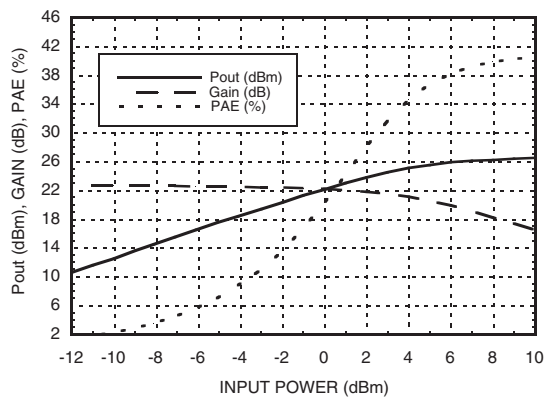
Psat vs. Temperature, Vs= 3.6V



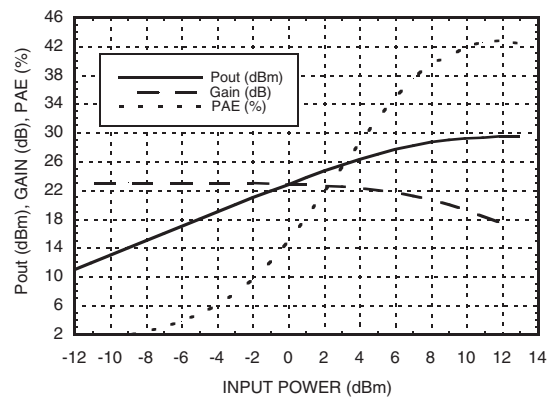
Psat vs. Temperature, Vs= 5V



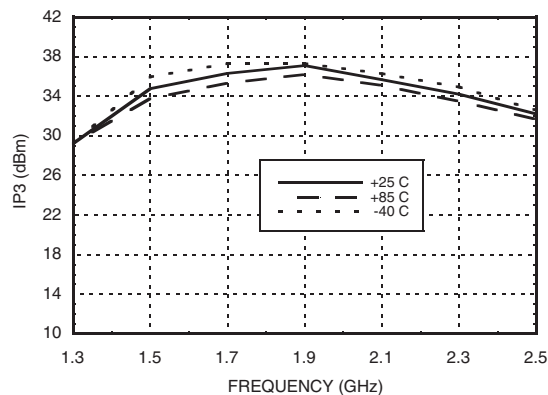
Power Compression@ 1.9 GHz, Vs= 3.6V



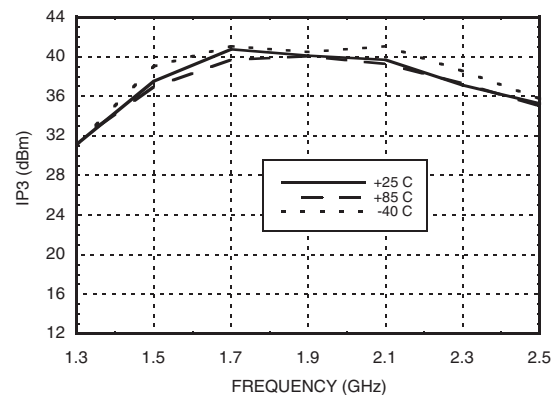
Power Compression@ 1.9 GHz, Vs= 5V



Output IP3 vs. Temperature, Vs= 3.6V



Output IP3 vs. Temperature, Vs= 5V

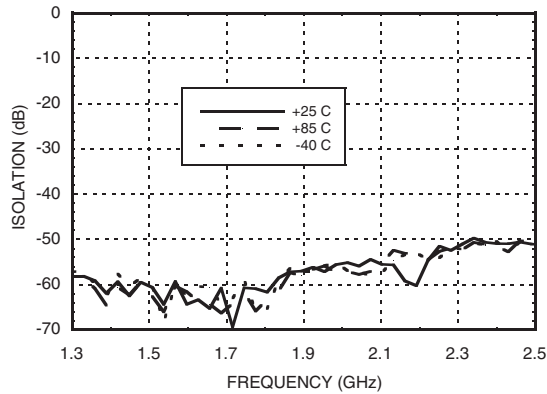




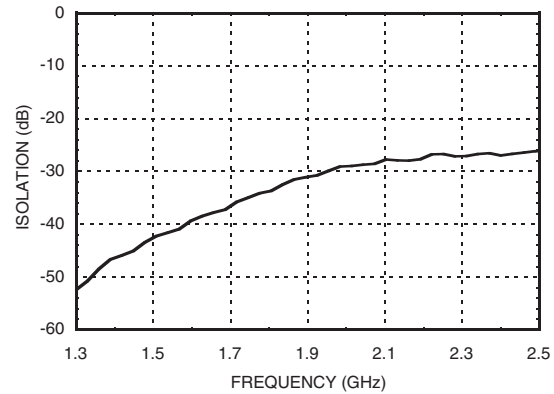
HMC413QS16G / 413QS16GE

GaAs InGaP HBT MMIC POWER AMPLIFIER, 1.6 - 2.2 GHz

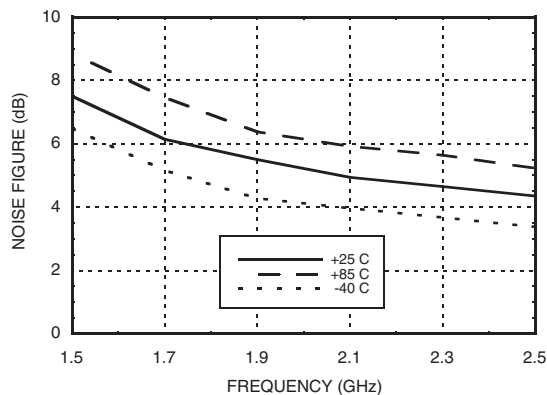
**Reverse Isolation
vs. Temperature, $V_s = 3.6V$**



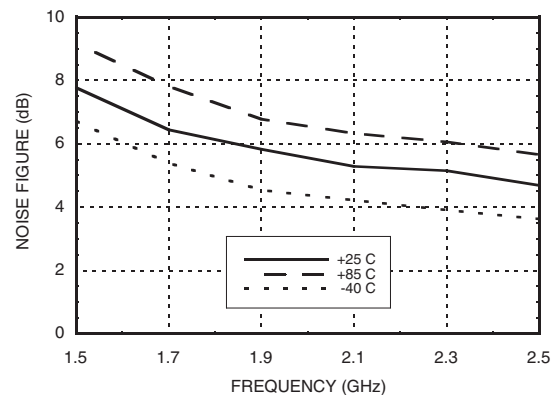
Power Down Isolation, $V_s = 3.6V$



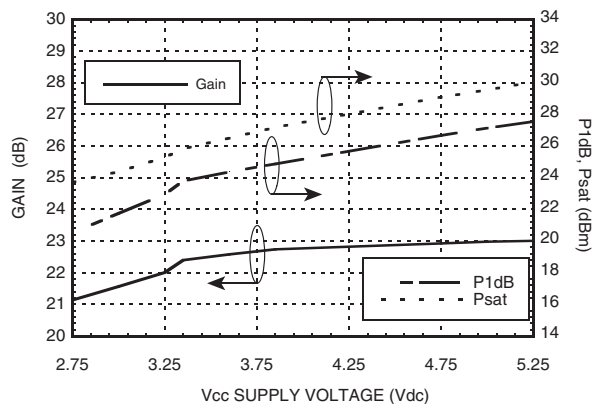
Noise Figure vs. Temperature, $V_s = 3.6V$



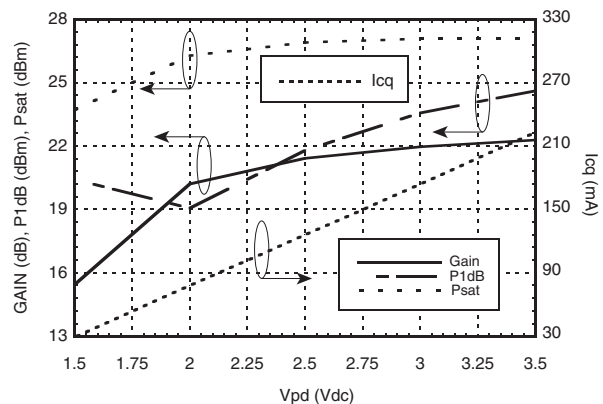
Noise Figure vs. Temperature, $V_s = 5V$




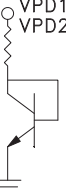
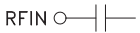
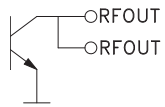
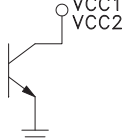
**Gain & Power vs.
Supply Voltage @ 1.9 GHz**



**Gain, Power & Quiescent Supply
Current vs. V_{pd} @ 1.9 GHz, $V_{cc} = +3.6V$**



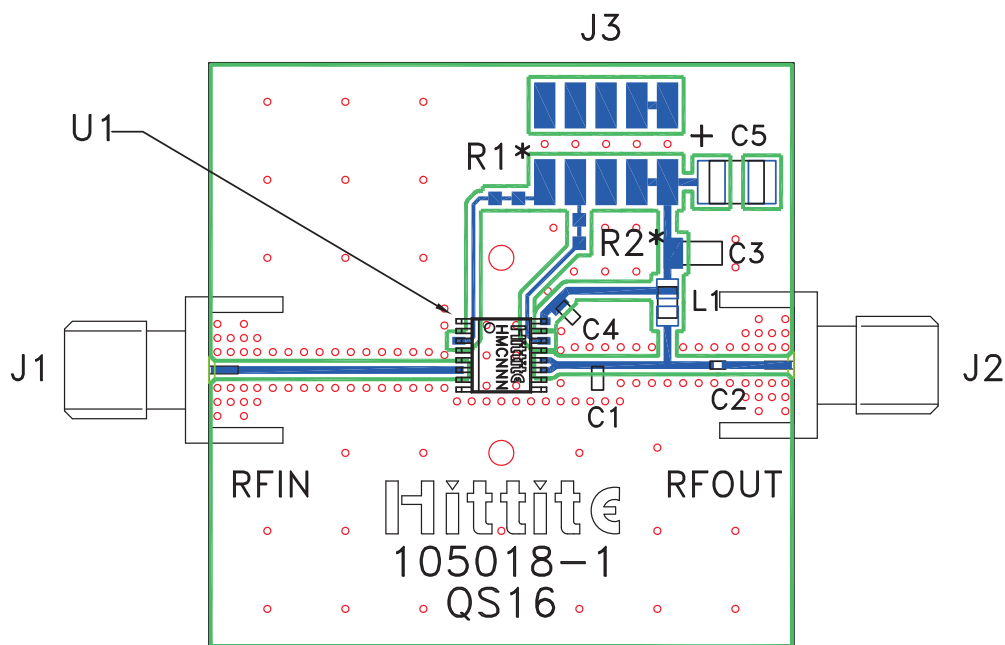
Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|---------------------------------|------------|--|---|
| 1, 2, 4, 5, 7, 8, 9, 10, 13, 15 | GND | Ground: Backside of package has exposed metal ground slug that must be connected to ground thru a short path. Vias under the device are required. |  |
| 3, 14 | Vpd1, Vpd2 | Power Control Pin. For maximum power, this pin should be connected to 3.6V. For 5V operation, a dropping resistor is required. A higher voltage is not recommended. For lower idle current, this voltage can be reduced. |  |
| 6 | RFIN | This pin is AC coupled and matched to 50 Ohms from 1.6 to 2.2 GHz. |  |
| 11, 12 | RFOUT | RF output and bias for the output stage. |  |
| 16 | Vcc | Power supply voltage for the first amplifier stage. An external bypass capacitor of 330 pF is required as shown in the application schematic. |  |



**GaAs InGaP HBT MMIC
POWER AMPLIFIER, 1.6 - 2.2 GHz**

Evaluation PCB



* For 5V operation on Vctl line, select R1, R2 such that 3.6V is presented on Pins 3 and 14.

List of Materials for Evaluation PCB 105000 [1]

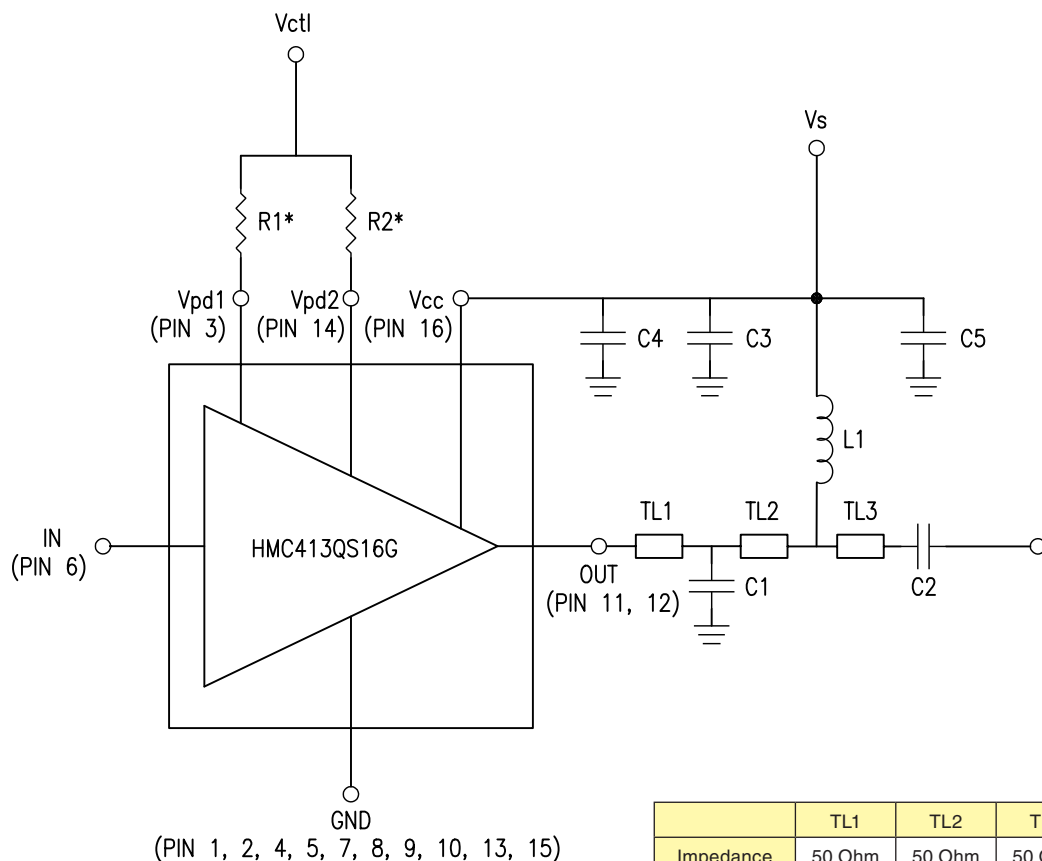
| Item | Description |
|---------|--------------------------------------|
| J1 - J2 | PCB Mount SMA RF Connector |
| J3 | 2 mm DC Header |
| C1 | 2.2 pF Capacitor, 0603 Pkg. |
| C2 | 10 pF Capacitor, 0402 Pkg. |
| C3 - C4 | 330 pF Capacitor, 0603 Pkg. |
| C5 | 2.2 μ F Capacitor, Tantalum |
| L1 | 16 nH Inductor 0603 Pkg. |
| U1 | HMC413QS16G / HMC413QS16GE Amplifier |
| PCB [2] | 105018 Eval Board |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

Application Circuit



* For 5V operation on Vctl line, select R1, R2 such that 3.6V is presented on Pins 3 and 14.